

FEATURES

Micropower at high voltage (18 V): 18 μ A typical
Single-supply operation: 2.7 V to 18 V
Dual-supply operation: ± 1.35 V to ± 9 V
Low input bias current: 20 pA
Gain bandwidth: 200 kHz
Unity-gain stable
Excellent electromagnetic interference immunity

APPLICATIONS

Portable operating systems
Current monitors
4 mA to 20 mA loop drivers
Buffer/level shifting
Multipole filters
Remote/wireless sensors
Low power transimpedance amplifiers

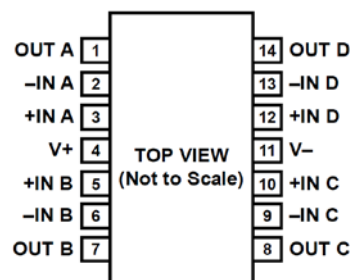
GENERAL DESCRIPTION

The AD8548 is a Quad, micropower, rail-to-rail input/output amplifier optimized for low power and wide operating supply voltage range applications.

The AD8548 operates from 2.7 V up to 18 V with a typical quiescent supply current of 18 μ A. The AD8548 also has high immunity to electromagnetic interference.

The combination of low supply current, low offset voltage, very low input bias current, wide supply range, and rail-to-rail input and output make the AD8548 ideal for current monitoring and current loops in process and motor control applications. The combination of precision specifications makes this device ideal for dc gain and buffering of sensor front ends or high impedance input sources in wireless or remote sensors or transmitters.

PIN CONFIGURATION



14-Lead SOIC_N (R Suffix)

Table 1. Micropower Op Amps

Supply Voltage	5 V	12 V to 16 V	36 V
Single	AD8500 ADA4505-1 AD8505 AD8541 AD8603	AD8663	
Dual	AD8502 ADA4505-2 AD8506 AD8542 AD8607	AD8667 OP281	OP295 ADA4062-2
Quad	AD8504 ADA4505-4 AD8508 AD8544 AD8609	AD8669 OP481	OP495 ADA4062-4

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SPECIFICATIONS

ELECTRICAL CHARACTERISTICS—2.7 V OPERATION

$V_{SY} = 2.7\text{ V}$, $V_{CM} = V_{SY}/2\text{ V}$, $T_A = 25^\circ\text{C}$, unless otherwise specified.

Table 2.

Parameter	Symbol	Test Conditions/Comments	Min	Typ	Max	Unit
INPUT CHARACTERISTICS						
Offset Voltage	V_{OS}	$V_{CM} = 0\text{ V to } 2.7\text{ V}$			4	mV
		$V_{CM} = 0.3\text{ V to } 2.4\text{ V}; -40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$			tbd	mV
		$V_{CM} = 0\text{ V to } 2.7\text{ V}; -40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$			tbd	mV
		$V_{CM} = 0.3\text{ V to } 2.4\text{ V}; -40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$			tbd	mV
		$V_{CM} = 0\text{ V to } 2.7\text{ V}; -40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$			tbd	mV
Input Bias Current	I_B	$-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$		1	10	pA
Input Offset Current	I_{OS}	$-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$			2.6	nA
		$-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$			20	pA
Input Voltage Range		$-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$			500	pA
		$-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$			2.7	V
Common-Mode Rejection Ratio	CMRR	$V_{CM} = 0\text{ V to } 2.7\text{ V}$	0			
		$V_{CM} = 0.3\text{ V to } 2.4\text{ V}; -40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$	79	95		dB
		$V_{CM} = 0\text{ V to } 2.7\text{ V}; -40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$	70			dB
		$V_{CM} = 0.3\text{ V to } 2.4\text{ V}; -40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$	64			dB
		$V_{CM} = 0\text{ V to } 2.7\text{ V}; -40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$	63			dB
Large Signal Voltage Gain	A_{VO}	$V_{CM} = 0\text{ V to } 2.7\text{ V}; -40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$	60			dB
		$R_L = 100\text{ k}\Omega, V_O = 0.5\text{ V to } 2.2\text{ V}$	94	105		dB
		$-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$	75			dB
		$-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$	65			dB
Offset Voltage Drift	$\Delta V_{OS}/\Delta T$			2		$\mu\text{V}/^{\circ}\text{C}$
Input Resistance	R_{IN}			10		G Ω
Input Capacitance, Differential Mode	C_{INDM}			3.5		pF
Input Capacitance, Common Mode	C_{INCM}			3.5		pF
OUTPUT CHARACTERISTICS						
Output Voltage High	V_{OH}	$R_L = 100\text{ k}\Omega$ to V_{CM} ; $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$	2.69			V
Output Voltage Low	V_{OL}	$R_L = 100\text{ k}\Omega$ to V_{CM} ; $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$			10	mV
Short-Circuit Current	I_{SC}			± 4		mA
Closed-Loop Output Impedance	Z_{OUT}	$f = 1\text{ kHz}, A_v = 1$		20		Ω
POWER SUPPLY						
Power Supply Rejection Ratio	PSRR	$V_{SY} = 2.7\text{ V to } 18\text{ V}$	105	125		dB
		$-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$	70			dB
Supply Current per Amplifier	I_{SY}	$I_O = 0\text{ mA}$		18	22	μA
		$-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$			33	μA
DYNAMIC PERFORMANCE						
Slew Rate	SR	$R_L = 1\text{ M}\Omega, C_L = 10\text{ pF}, A_v = 1$		38		V/ms
Settling Time to 0.1%	t_s	$V_{IN} = 1\text{ V step}, R_L = 100\text{ k}\Omega, C_L = 10\text{ pF}$		14		μs
Gain Bandwidth Product	GBP	$R_L = 1\text{ M}\Omega, C_L = 10\text{ pF}, A_v = 1$		170		kHz
Phase Margin	Φ_M	$R_L = 1\text{ M}\Omega, C_L = 10\text{ pF}, A_v = 1$		69		Degrees
Channel Separation	CS	$f = 10\text{ kHz}, R_L = 1\text{ M}\Omega$		105		dB
EMI Rejection Ratio of IN+	EMIRR	$V_{IN} = 100\text{ mV}_{PEAK}; f = 400\text{ MHz}, 900\text{ MHz}, 1800\text{ MHz}, 2400\text{ MHz}$		90		dB
NOISE PERFORMANCE						
Voltage Noise	$e_n\text{ p-p}$	$f = 0.1\text{ Hz to } 10\text{ Hz}$		6		$\mu\text{V p-p}$
Voltage Noise Density	e_n	$f = 1\text{ kHz}$		60		$\text{nV}/\sqrt{\text{Hz}}$
		$f = 10\text{ kHz}$		56		$\text{nV}/\sqrt{\text{Hz}}$

Parameter	Symbol	Test Conditions/Comments	Min	Typ	Max	Unit
Current Noise Density	i_n	$f = 1 \text{ kHz}$		0.1		$\text{pA}/\sqrt{\text{Hz}}$

ELECTRICAL CHARACTERISTICS—10 V OPERATION

$V_{SY} = 10 \text{ V}$, $V_{CM} = V_{SY}/2 \text{ V}$, $T_A = 25^\circ\text{C}$, unless otherwise specified.

Table 3.

Parameter	Symbol	Test Conditions/Comments	Min	Typ	Max	Unit
INPUT CHARACTERISTICS						
Offset Voltage	V _{OS}	V _{CM} = 0 V to 10 V V _{CM} = 0 V to 10 V; −40°C ≤ T _A ≤ +85°C V _{CM} = 0 V to 10 V; −40°C ≤ T _A ≤ +125°C			4 tbd tbd	mV mV mV
Input Bias Current	I _B	−40°C ≤ T _A ≤ +125°C		2	15	pA
Input Offset Current	I _{OS}	−40°C ≤ T _A ≤ +125°C			2.6 30 500	nA pA pA
Input Voltage Range			0		10	V
Common-Mode Rejection Ratio	CMRR	V _{CM} = 0 V to 10 V V _{CM} = 0 V to 10 V; −40°C ≤ T _A ≤ +85°C V _{CM} = 0 V to 10 V; −40°C ≤ T _A ≤ +125°C	90 72 64	105		dB dB dB
Large Signal Voltage Gain	A _{VO}	R _L = 100 kΩ, V _O = 0.5 V to 9.5 V −40°C ≤ T _A ≤ +85°C −40°C ≤ T _A ≤ +125°C	105 95 67	120		dB dB dB
Offset Voltage Drift	ΔV _{OS} /ΔT			2		μV/°C
Input Resistance	R _{IN}			10		GΩ
Input Capacitance, Differential Mode	C _{INDM}			3.5		pF
Input Capacitance, Common Mode	C _{INCM}			3.5		pF
OUTPUT CHARACTERISTICS						
Output Voltage High	V _{OH}	R _L = 100 kΩ to V _{CM} ; −40°C ≤ T _A ≤ +125°C	9.98			V
Output Voltage Low	V _{OL}	R _L = 100 kΩ to V _{CM} ; −40°C ≤ T _A ≤ +125°C			20	mV
Short-Circuit Current	I _{SC}			±11		mA
Closed-Loop Output Impedance	Z _{OUT}	f = 1 kHz, A _V = 1		15		Ω
POWER SUPPLY						
Power Supply Rejection Ratio	PSRR	V _{SY} = 2.7 V to 18 V −40°C ≤ T _A ≤ +125°C	105 70	125		dB dB
Supply Current per Amplifier	I _{SY}	I _O = 0 mA −40°C ≤ T _A ≤ +125°C		18 33	22	μA μA
DYNAMIC PERFORMANCE						
Slew Rate	SR	R _L = 1 MΩ, C _L = 10 pF, A _V = 1		60		V/ms
Settling Time to 0.1%	t _s	V _{IN} = 1 V step, R _L = 100 kΩ, C _L = 10 pF		13		μs
Gain Bandwidth Product	GBP	R _L = 1 MΩ, C _L = 10 pF, A _V = 1		200		kHz
Phase Margin	Φ _M	R _L = 1 MΩ, C _L = 10 pF, A _V = 1		60		Degrees
Channel Separation	CS	f = 10 kHz, R _L = 1 MΩ		105		dB
EMI Rejection Ratio of IN+	EMIRR	V _{IN} = 100 mV _{PEAK} ; f = 400 MHz, 900 MHz, 1800 MHz, 2400 MHz		90		dB
NOISE PERFORMANCE						
Voltage Noise	e _n p-p	f = 0.1 Hz to 10 Hz		5		μV p-p
Voltage Noise Density	e _n	f = 1 kHz f = 10 kHz		50 45		nV/√Hz nV/√Hz
Current Noise Density	i _n	f = 1 kHz		0.1		pA/√Hz

ELECTRICAL CHARACTERISTICS—18 V OPERATION

$V_{SY} = 18\text{ V}$, $V_{CM} = V_{SY}/2\text{ V}$, $T_A = 25^\circ\text{C}$, unless otherwise specified.

Table 4.

Parameter	Symbol	Test Conditions/Comments	Min	Typ	Max	Unit
INPUT CHARACTERISTICS						
Offset Voltage	V _{OS}	V _{CM} = 0 V to 18 V V _{CM} = 0.3 V to 17.7 V; −40°C ≤ T _A ≤ +85°C V _{CM} = 0 V to 18 V; −40°C ≤ T _A ≤ +85°C V _{CM} = 0.3 V to 17.7 V; −40°C ≤ T _A ≤ +125°C V _{CM} = 0 V to 18 V; −40°C ≤ T _A ≤ +125°C			4 tbd tbd tbd tbd	V mV mV mV mV
Input Bias Current	I _B	−40°C ≤ T _A ≤ +125°C		5	20	pA
Input Offset Current	I _{OS}	−40°C ≤ T _A ≤ +125°C			2.9 40 500	nA pA pA
Input Voltage Range			0		18	V
Common-Mode Rejection Ratio	CMRR	V _{CM} = 0 V to 18 V V _{CM} = 0.3 V to 17.7 V; −40°C ≤ T _A ≤ +85°C V _{CM} = 0 V to 18 V; −40°C ≤ T _A ≤ +85°C V _{CM} = 0.3 V to 17.7 V; −40°C ≤ T _A ≤ +125°C V _{CM} = 0 V to 18 V; −40°C ≤ T _A ≤ +125°C	95 83 74 80 67	110		dB dB dB dB dB
Large Signal Voltage Gain	A _{VO}	R _L = 100 kΩ, V _O = 0.5 V to 17.5 V −40°C ≤ T _A ≤ +85°C −40°C ≤ T _A ≤ +125°C	110 105 73	120		dB dB dB
Offset Voltage Drift	ΔV _{OS} /ΔT			2		μV/°C
Input Resistance	R _{IN}			10		GΩ
Input Capacitance, Differential Mode	C _{INDM}			3.5		pF
Input Capacitance, Common Mode	C _{INCM}			10.5		pF
OUTPUT CHARACTERISTICS						
Output Voltage High	V _{OH}	R _L = 100 kΩ to V _{CM} ; −40°C ≤ T _A ≤ +125°C	17.97			V
Output Voltage Low	V _{OL}	R _L = 100 kΩ to V _{CM} ; −40°C ≤ T _A ≤ +125°C			30	mV
Short-Circuit Current	I _{SC}			±12		mA
Closed-Loop Output Impedance	Z _{OUT}	f = 1 kHz, A _V = 1		15		Ω
POWER SUPPLY						
Power Supply Rejection Ratio	PSRR	V _{SY} = 2.7 V to 18 V −40°C ≤ T _A ≤ +125°C	105 70	125		dB dB
Supply Current per Amplifier	I _{SY}	I _O = 0 mA −40°C ≤ T _A ≤ +125°C		18 22 33		μA μA μA
DYNAMIC PERFORMANCE						
Slew Rate	SR	R _L = 1 MΩ, C _L = 10 pF, A _V = 1		70		V/ms
Settling Time to 0.1%	t _s	V _{IN} = 1 V step, R _L = 100 kΩ, C _L = 10 pF		12		μs
Gain Bandwidth Product	GBP	R _L = 1 MΩ, C _L = 10 pF, A _V = 1		200		kHz
Phase Margin	Φ _M	R _L = 1 MΩ, C _L = 10 pF, A _V = 1		60		Degrees
Channel Separation	CS	f = 10 kHz, R _L = 1 MΩ		105		dB
EMI Rejection Ratio of IN+	EMIRR	V _{IN} = 100 mV _{PEAK} ; f = 400 MHz, 900 MHz, 1800 MHz, 2400 MHz		90		dB
NOISE PERFORMANCE						
Voltage Noise	e _n p-p	f = 0.1 Hz to 10 Hz		5		μV p-p
Voltage Noise Density	e _n	f = 1 kHz f = 10 kHz		50 45		nV/√Hz nV/√Hz
Current Noise Density	i _n	f = 1 kHz		0.1		pA/√Hz

ABSOLUTE MAXIMUM RATINGS

Table 4.

Parameter	Rating
Supply Voltage	20.5 V
Input Voltage	(V ₋) – 300 mV to (V ₊) + 300 mV
Input Current ¹	±10 mA
Differential Input Voltage	±V _{SY}
Output Short-Circuit Duration to GND	Indefinite
Temperature Range	
Storage	–65°C to +150°C
Operating	–40°C to +125°C
Junction	–65°C to +150°C
Lead Temperature (Soldering, 60 sec)	300°C

¹The input pins have clamp diodes to the power supply pins. Limit the input current to 10 mA or less whenever input signals exceed the power supply rail by 0.3 V.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

θ_{JA} is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages using a standard 4-layer board.

Table 5. Thermal Resistance

Package Type	θ_{JA}	θ_{JC}	Unit
14-Lead SOIC (R-14)	142	45	°C/W

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

